

Stereo 2.6W Audio Power Amplifier (with DC Volume Control)

Features

- **Low Operating Current about 9mA (typical)**
- **Improved Depop Circuitry to Eliminate Turn-on and Turn-off Transients in Outputs**
- **32-Step Volume Adjustable by DC Voltage with Hysteresis**
- **Output Power at 1% THD+N**
 - 2.4W, at $V_{DD}=5V$, BTLMode, $R_L=3\Omega$
 - 2W, at $V_{DD}=5V$, BTLMode, $R_L=4\Omega$
- **at 10% THD+N**
 - 3.1W, at $V_{DD}=5V$, BTLMode, $R_L=3\Omega$
 - 2.6W, at $V_{DD}=5V$, BTLMode, $R_L=4\Omega$
- **Two Output Modes: BTL and SE Modes Selected by SE/BTL Pin**
- **Low Current Consumption in Shutdown Mode (1mA, typical)**
- **Short Circuit Protection**
- **Thermal Shutdown Protection and Over-Current Protection Circuitry**
- **The OUTP Signal and the INN Signal are Outphase**
- **Power Enhanced Package (DIP-16/DIP-16A)**
- **Lead Free and Green Devices Available (RoHS Compliant)**

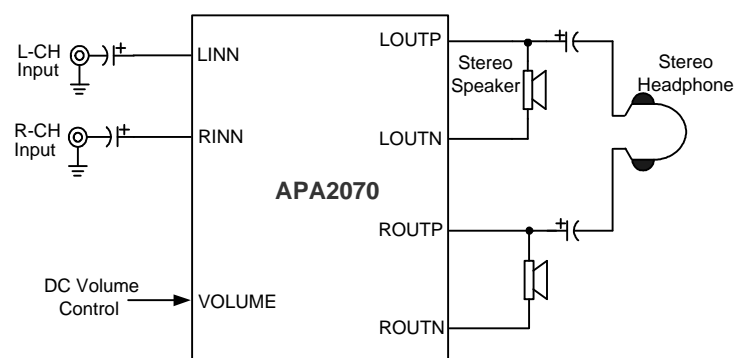
General Description

The APA2070 is a monolithic integrated circuit, which provides precise DC volume control, and a stereo bridged audio power amplifiers capable of producing 2.6W (2W) into 4Ω with less than 10% (1.0%) THD+N. The attenuator range of the volume control in APA2070 is from 18dB ($V_{VOLUME}=0V$) to -80dB ($V_{VOLUME}=3.54V$) with 32 steps. The advantage of internal gain setting can be less components and PCB area. Both the depop circuitry and the thermal shutdown protection circuitry are integrated in the APA2070, that reduce pops and clicks noise during power up or shutdown mode operation. It also improves the power off pop noise and protects the chip being destroyed by over temperature and short current failure. To simplify the audio system design, the APA2070 combines a stereo bridge-tied load (BTL) mode for speaker drive and a stereo single-end (SE) mode for headphone drive into a single chip, where both modes are easily switched by the SE/BTL input control pin signal.

Applications

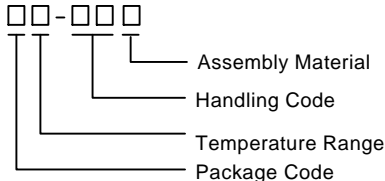
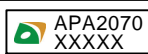
- **Notebook PC**
- **LCD Monitor or TV**

Simplified Application Circuit



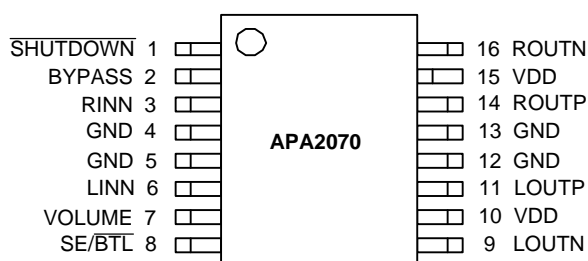
ANPEC reserves the right to make changes to improve reliability or manufacturability without notice, and advise customers to obtain the latest version of relevant information to verify before placing orders.

Ordering and Marking Information

<p>APA2070</p>  <p>Assembly Material Handling Code Temperature Range Package Code</p>	<p>Package Code J : DIP-16 / DIP-16A Operating Ambient Temperature Range I : - 40 to 85 °C Handling Code TU : Tube Assembly Material L : Lead Free Device G : Halogen and Lead Free Device</p>
<p>APA2070 J :</p> 	<p>XXXXX - Date Code</p>

Note : ANPEC lead-free products contain molding compounds/die attach materials and 100% matte tin plate termination finish; which are fully compliant with RoHS. ANPEC lead-free products meet or exceed the lead-free requirements of IPC/JEDEC J-STD-020D for MSL classification at lead-free peak reflow temperature. ANPEC defines “Green” to mean lead-free (RoHS compliant) and halogen free (Br or Cl does not exceed 900ppm by weight in homogeneous material and total of Br and Cl does not exceed 1500ppm by weight).

Pin Configuration



Absolute Maximum Ratings (Note 1)

Symbol	Parameter	Rating	Unit
V_{DD}	Supply Voltage (VDD to GND)	-0.3 to 6	V
	Input Voltage ($\overline{SE/BTL}$, $\overline{SHUTDOWN}$, VOLUME, RINN, LINN to GND)	-0.3 to $V_{DD} + 0.3$	V
	Output Voltage (LOUTN, LOUTP, ROUTP, ROUTN to GND)	-0.3 to $V_{DD} + 0.3$	V
T_A	Operating Ambient Temperature Range	-40 to 85	°C
T_J	Maximum Junction Temperature	150	°C
T_{STG}	Storage Temperature Range	-65 to +150	°C
T_{SDR}	Maximum Lead Soldering Temperature, 10 Seconds	260	°C
P_D	Power Dissipation	Internally Limited	W

Note 1: Absolute Maximum Ratings are those values beyond which the life of a device may be impaired. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Thermal Characteristics

Symbol	Parameter	Typical Value	Unit
θ_{JA}	Junction-to-Ambient Resistance in Free Air ^(Note 2)	45	°C/W
θ_{JC}	Junction-to-Case Resistance in Free Air ^(Note 3)	8	°C/W

Note 2: θ_{JA} is measured with the component mounted on a high effective thermal conductivity test board in free air.

Note 3: The case temperature is measured at the center of the GND pin on the beside of the DIP-16/DIP-16A package.

Recommended Operating Conditions (Note 4)

Symbol	Parameter	Range	Unit	
V_{DD}	Supply Voltage	4.5 ~ 5.5	V	
V_{IH}	High Level Threshold Voltage	$\overline{\text{SHUTDOWN}}$		$0.4V_{DD} \sim V_{DD}$
		$\text{SE}/\overline{\text{BTL}}$		$0.8V_{DD} \sim V_{DD}$
V_{IL}	Low Level Threshold Voltage	$\overline{\text{SHUTDOWN}}$		0 ~ 1.0
		$\text{SE}/\overline{\text{BTL}}$		0 ~ 1.0
V_{CIM}	Common Mode Input Voltage	$\sim V_{DD}-1.0$		
T_A	Ambient Temperature Range	-40 ~ 80	°C	
T_J	Junction Temperature Range	-40 ~ 125		
R_L	Speaker Resistance	3 ~	Ω	
R_L	Headphone Resistance	16 ~		

Note 4 : Refer to the typical application circuit

Electrical Characteristics

Unless otherwise specified, these specifications apply over $V_{DD}=5V$, $V_{GND}=0V$ and $T_A = -40 \sim 85$ °C. Typical values are at $T_A=25$ °C.

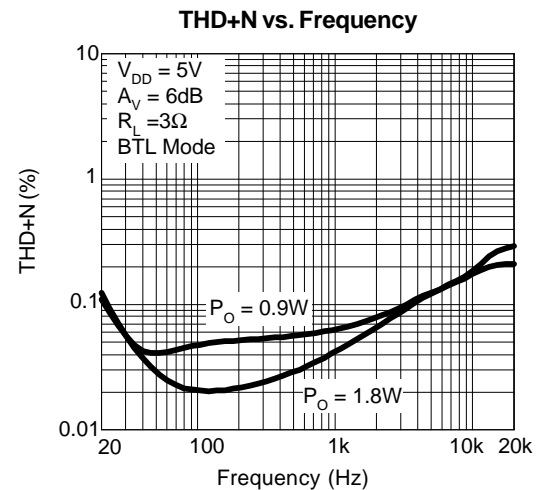
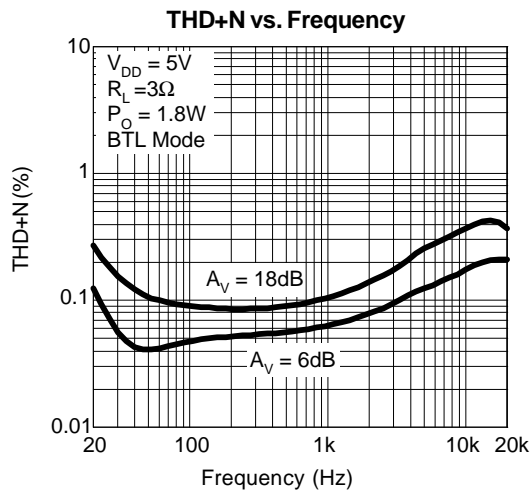
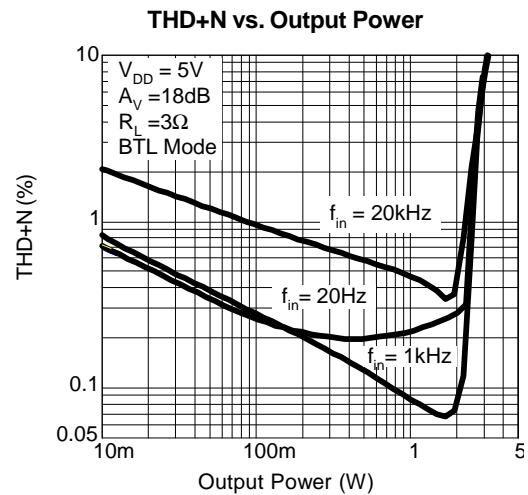
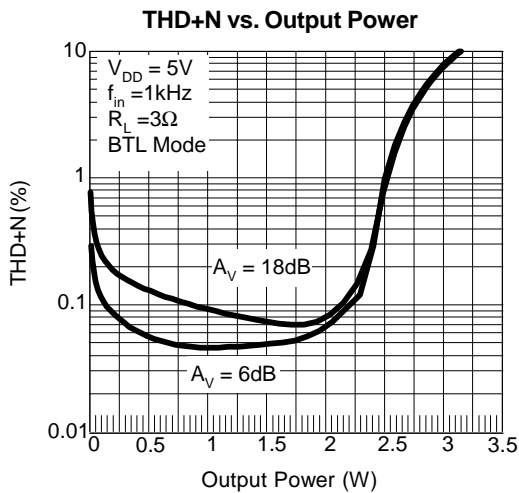
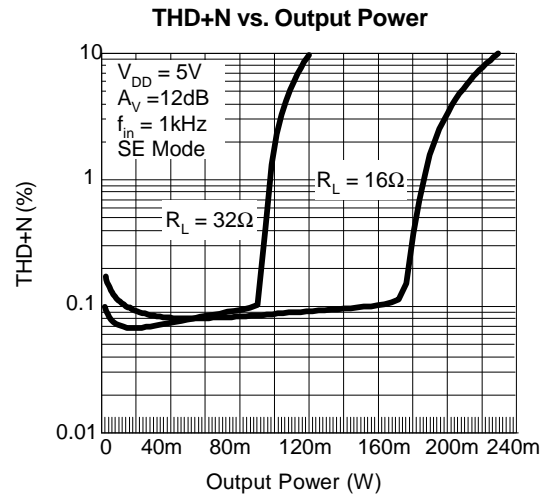
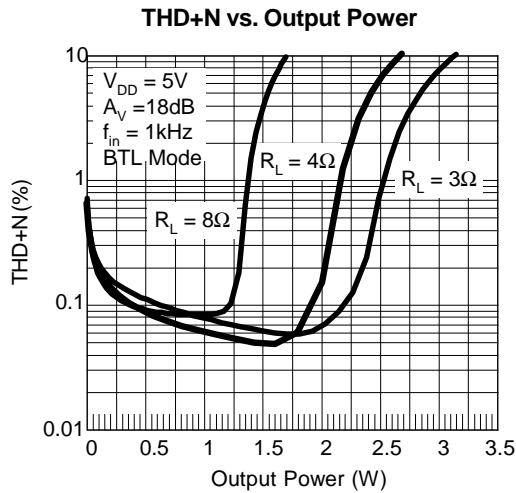
Symbol	Parameter	Test Conditions	APA2070			Unit
			Min.	Typ.	Max.	
I_{DD}	Supply Current	$V_{SE/\overline{BTL}}=0V$	-	9	20	mA
		$V_{SE/\overline{BTL}}=5V$	-	4	10	
I_{SD}	Shutdown Current	$V_{SE/\overline{BTL}}=0V$ $V_{\overline{\text{SHUTDOWN}}}=0V$	-	1	-	μA
$T_{START-UP}$	Start-Up Time from Shutdown	$C_{BYPASS}=2.2\mu F$	-	1.6	-	s
BTL MODE. $V_{DD}=5V$, GAIN=6dB (UNLESS OTHERWISE NOTED)						
P_O	Output Power	THD+N=10%, $R_L=3\Omega$, $f_{in}=1kHz$	-	3.1	-	W
		THD+N =10%, $R_L=4\Omega$, $f_{in}=1kHz$	-	2.6	-	
		THD+N =10%, $R_L=8\Omega$, $f_{in}=1kHz$	-	1.6	-	
		THD+N =1%, $R_L=3\Omega$, $f_{in}=1kHz$	-	2.4	-	
		THD+N =1%, $R_L=4\Omega$, $f_{in}=1kHz$	-	2	-	
		THD+N =0.5%, $R_L=8\Omega$, $f_{in}=1kHz$	1	1.3	-	
THD+N	Total Harmonic Distortion Pulse Noise	$P_O=1.2W$, $R_L=4\Omega$, $f_{in}=1kHz$	-	0.07	-	%
		$P_O=0.9W$, $R_L=8\Omega$, $f_{in}=1kHz$	-	0.08	-	

Electrical Characteristics (Cont.)

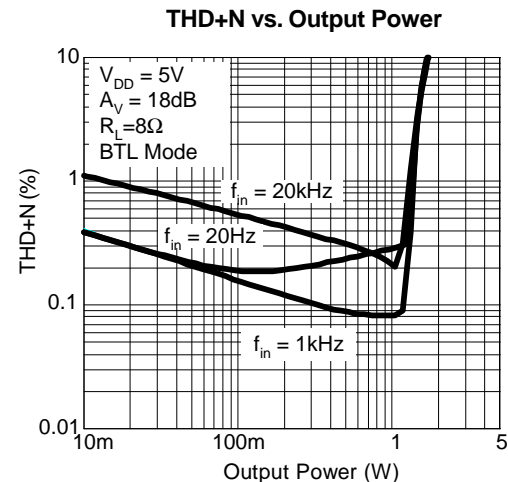
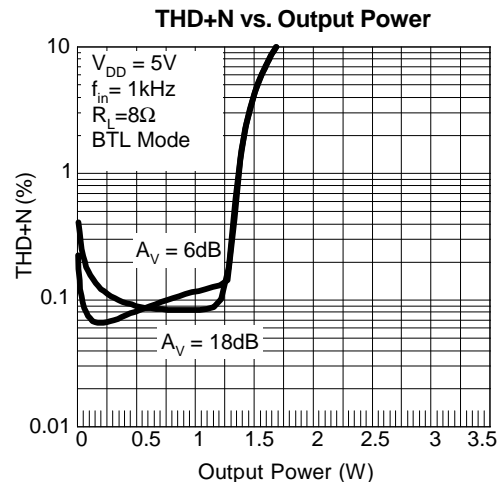
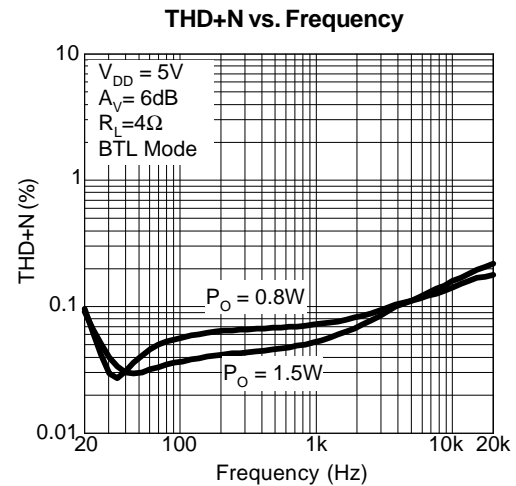
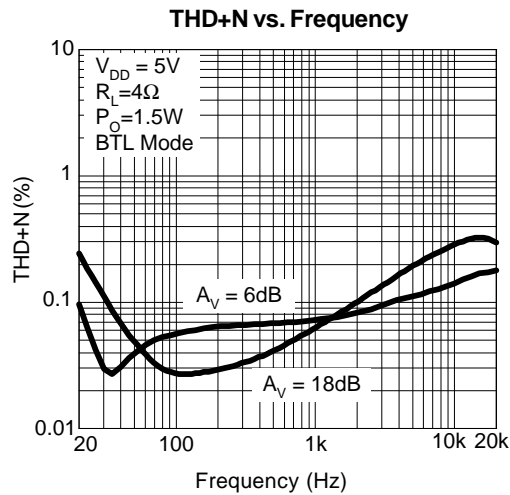
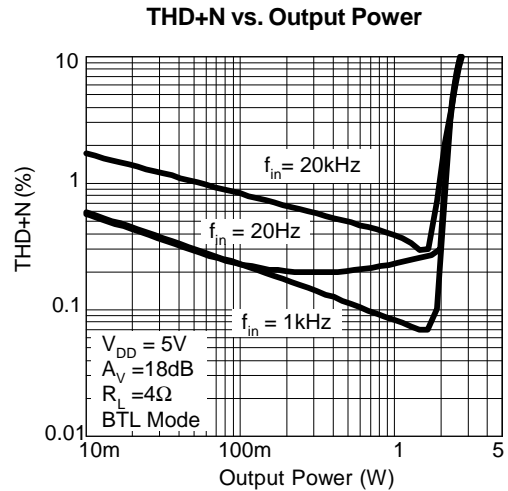
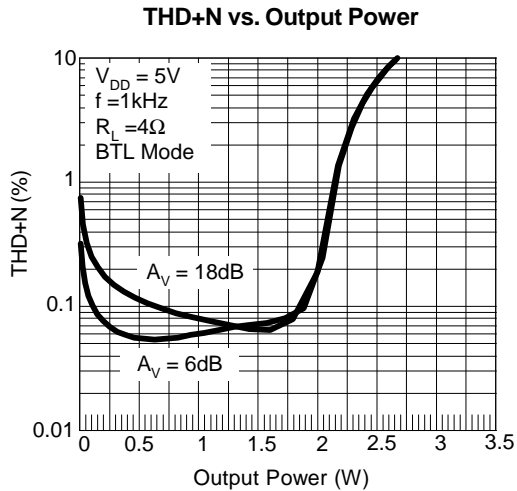
Unless otherwise specified, these specifications apply over $V_{DD}=5V$, $V_{GND}=0V$ and $T_A = -40 \sim 85 \text{ }^\circ\text{C}$. Typical values are at $T_A=25^\circ\text{C}$.

Symbol	Parameter	Test Conditions	APA2070			Unit
			Min.	Typ.	Max.	
BTL MODE. $V_{DD}=5V$, GAIN=6dB (UNLESS OTHERWISE NOTED) (CONT.)						
PSRR	Power Supply Rejection Ratio	V_{DD} Ripple=0.1Vrms, $R_L=8\Omega$, $C_{BYPASS}=2.2\mu F$, $f_{in}=217\text{Hz}$	-	60	-	dB
Crosstalk	Channel Separation	$C_{BYPASS}=2.2\mu F$, $R_L=8\Omega$, $f_{in}=1\text{kHz}$	-	90	-	dB
V_{OS}	Output Offset Voltage	$R_L=4\Omega$	-	5	-	mV
S/N	Signal to Noise Ratio	$P_O=1.1W$, $R_L=8\Omega$, A_Weighting	-	95	-	dB
SE MODE. $V_{DD}=5V$, GAIN=0dB						
P_o	Output Power	THD+N=10%, $R_L=16\Omega$, $f_{in}=1\text{kHz}$	-	220	-	mW
		THD+N =10%, $R_L=32\Omega$, $f_{in}=1\text{kHz}$	-	120	-	
		THD+N =1%, $R_L=16\Omega$, $f_{in}=1\text{kHz}$	-	160	-	
		THD+N =1%, $R_L=32\Omega$, $f_{in}=1\text{kHz}$	-	95	-	
THD+N	Total Harmonic Distortion Pulse Noise	$P_O=125\text{mW}$, $R_L=16\Omega$, $f_{in}=1\text{kHz}$	-	0.09	-	%
		$P_O=65\text{mW}$, $R_L=32\Omega$, $f_{in}=1\text{kHz}$	-	0.09	-	
PSRR	Power Supply Rejection Ratio	V_{DD} Ripple =0.1Vrms, $R_L=32\Omega$, $C_{BYPASS}=2.2\mu F$, $f_{in}=217\text{Hz}$	-	60	-	dB
Crosstalk	Channel Separation	$C_{BYPASS}=2.2\mu F$, $R_L=32\Omega$, $f_{in}=1\text{kHz}$	-	60	-	dB
V_{OS}	Output Offset Voltage	$R_L=32\Omega$	-	5	-	mV
S/N	Signal to Noise Ratio	$P_O=75\text{mW}$, $R_L=32\Omega$, A_Weighting	-	100	-	dB

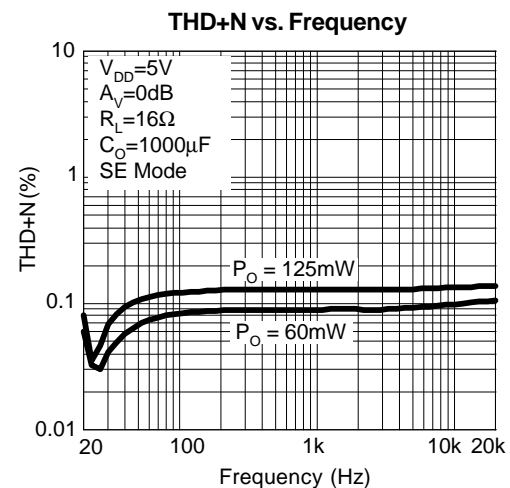
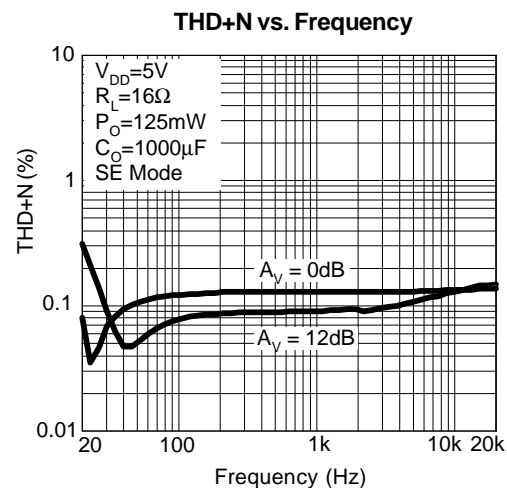
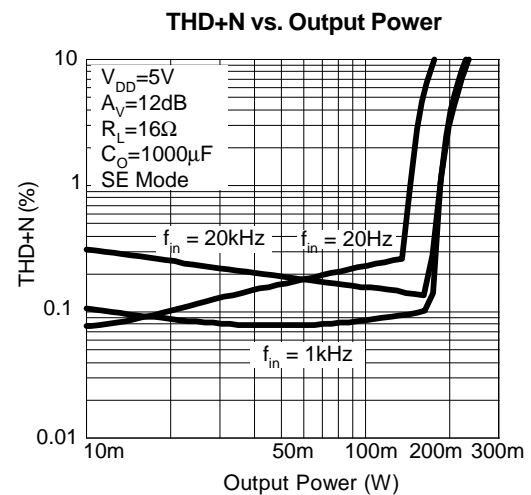
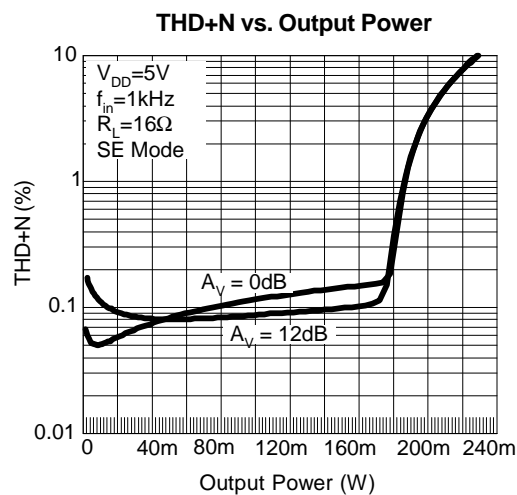
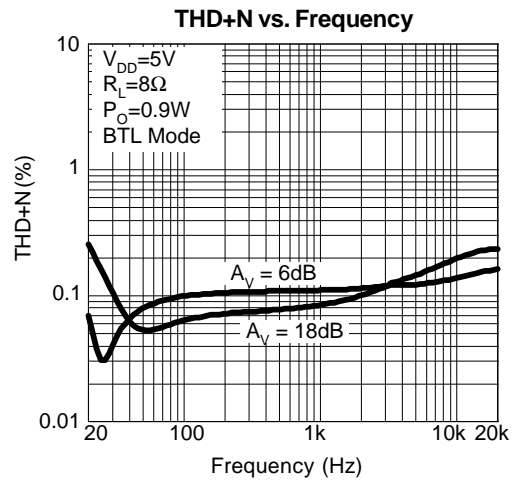
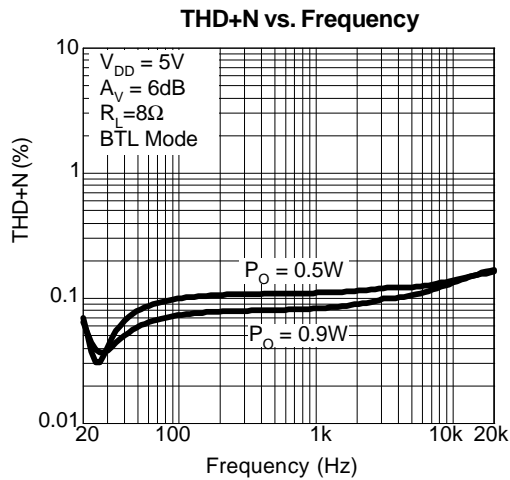
Typical Operating Characteristics



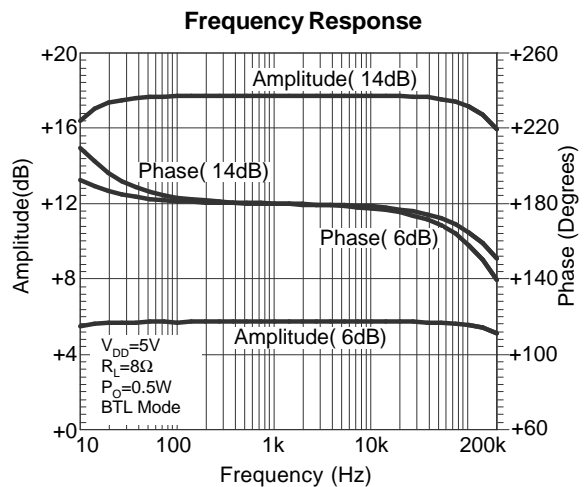
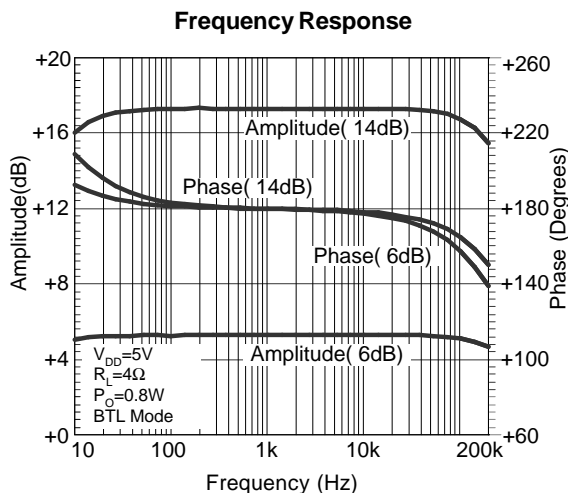
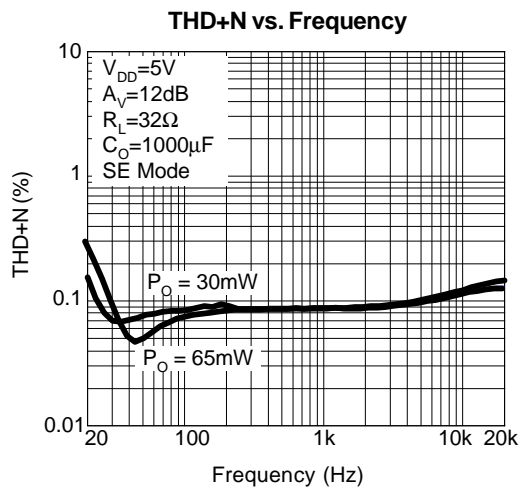
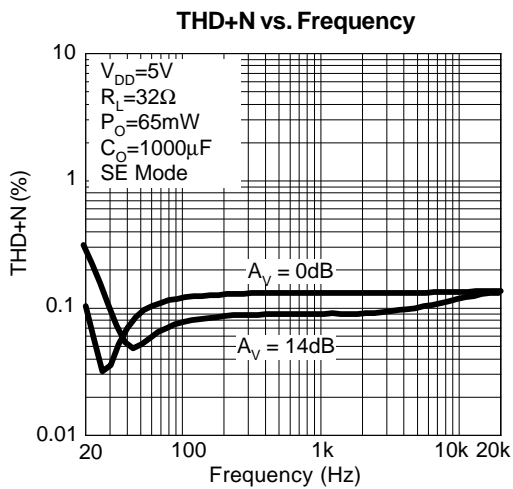
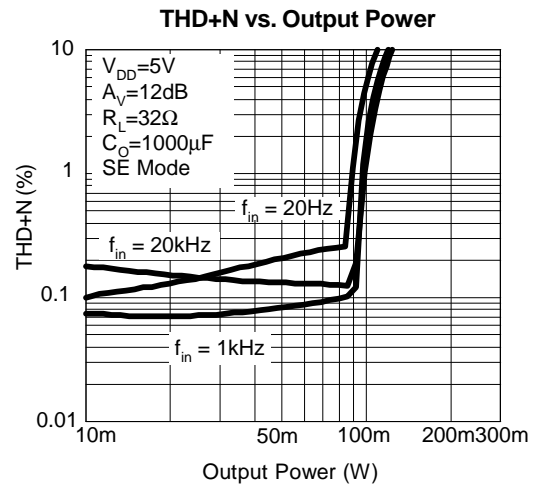
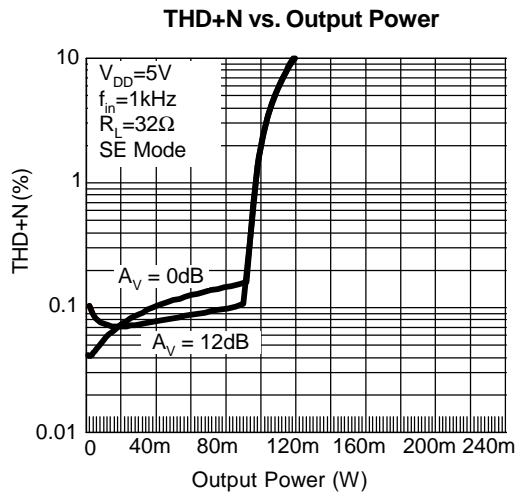
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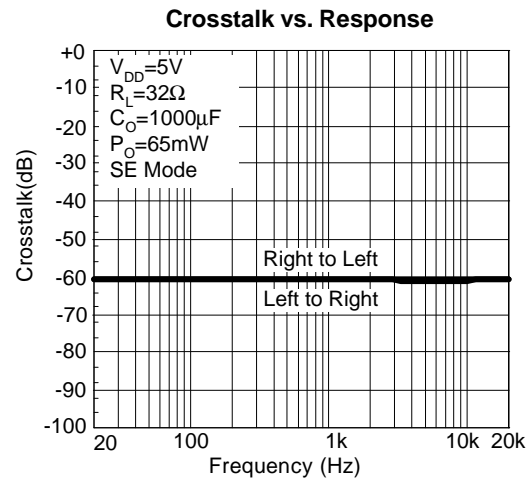
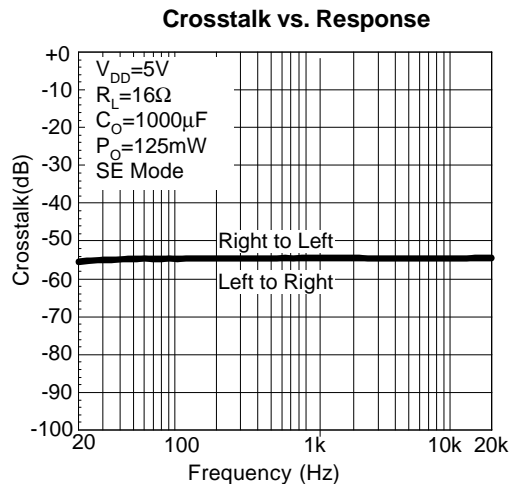
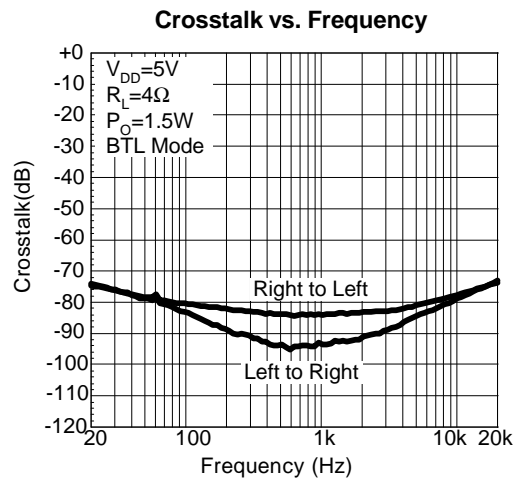
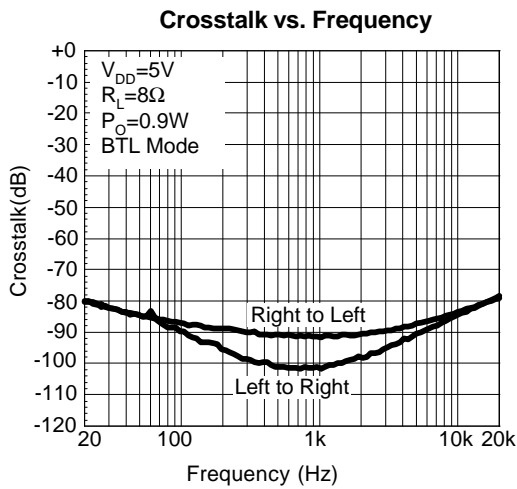
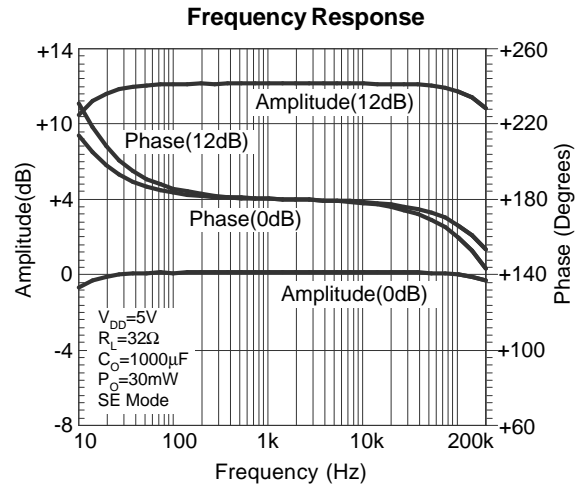
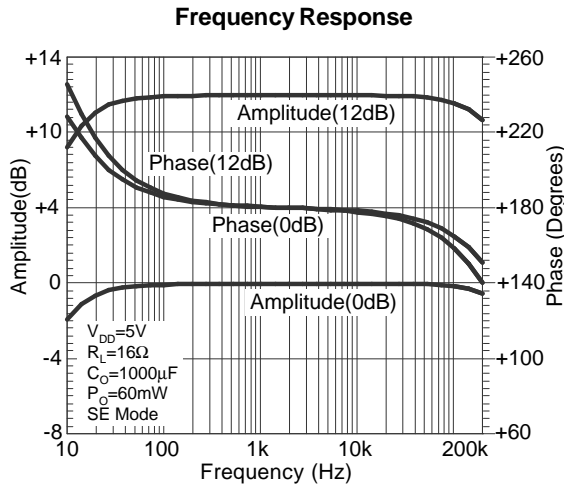
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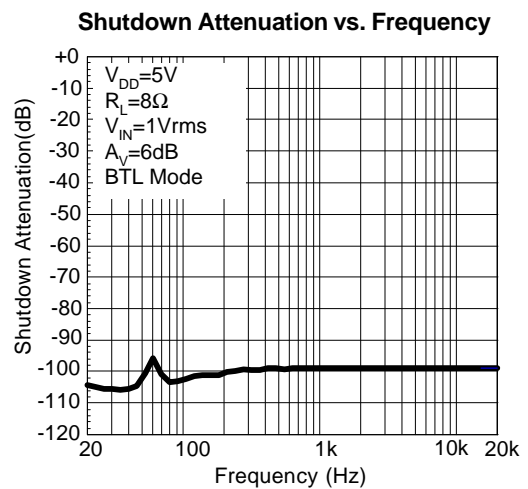
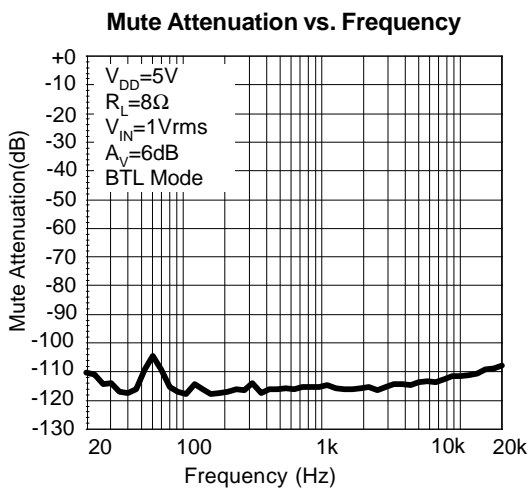
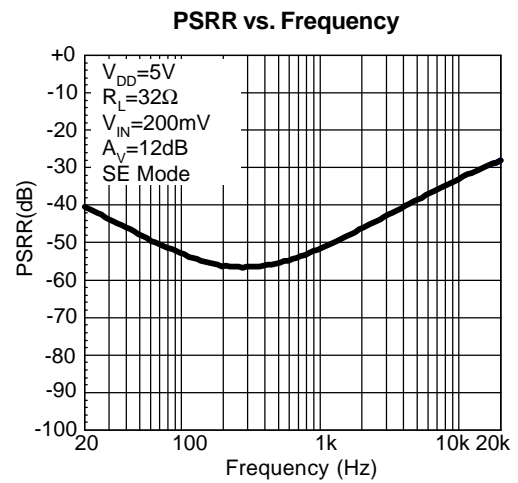
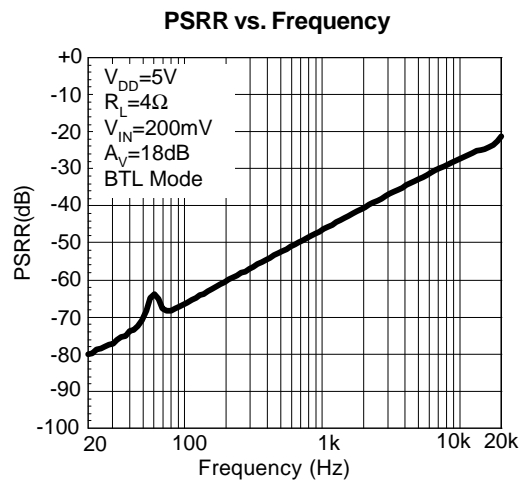
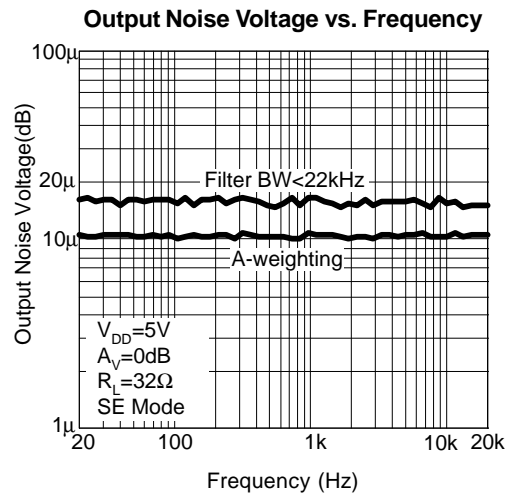
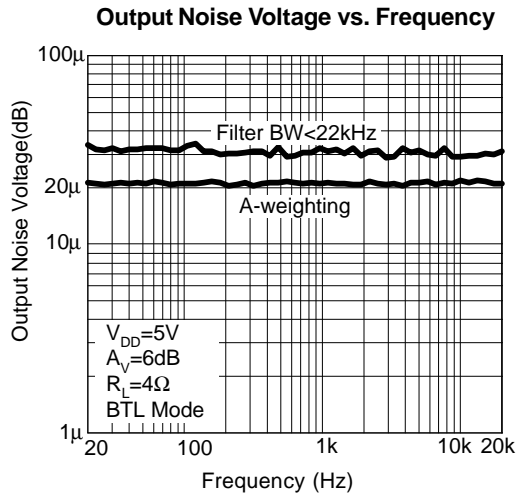
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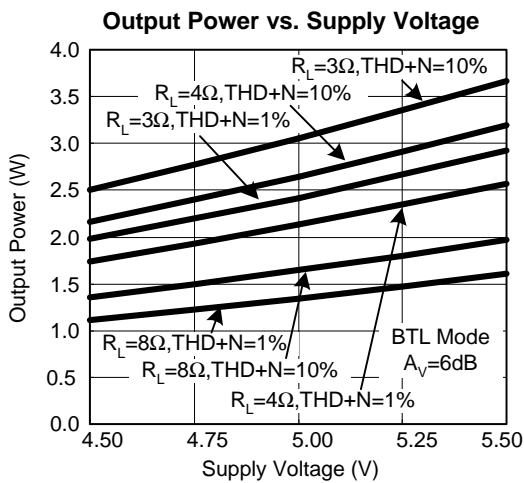
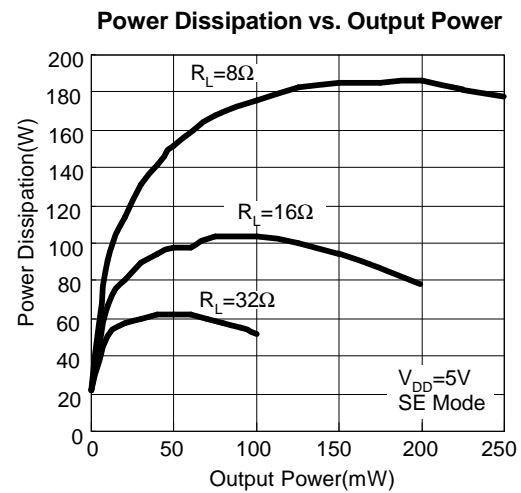
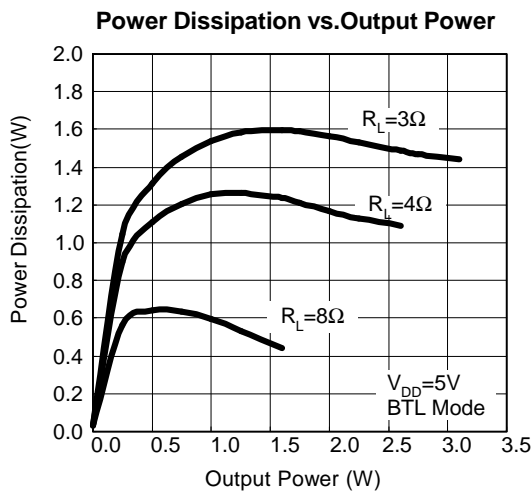
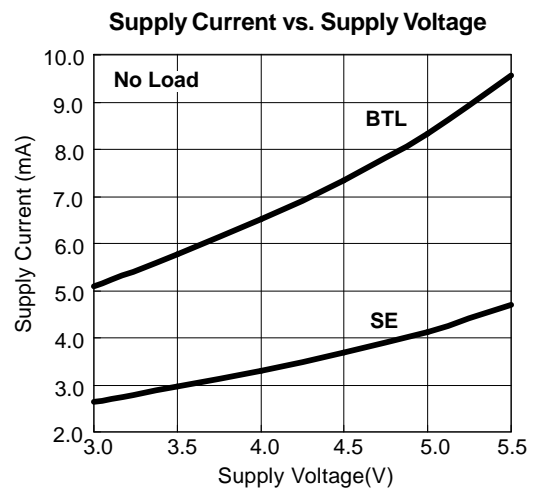
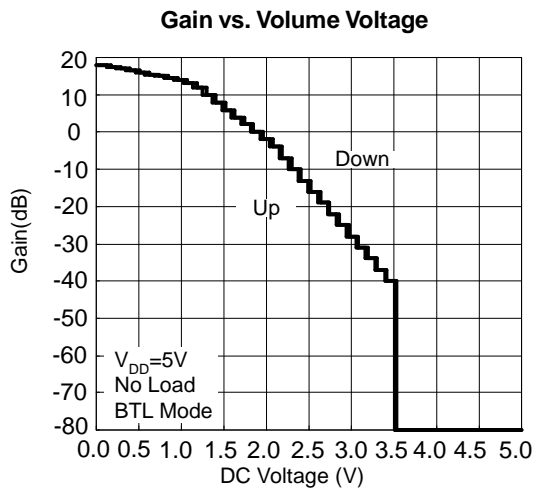
Typical Operating Characteristics (Cont.)



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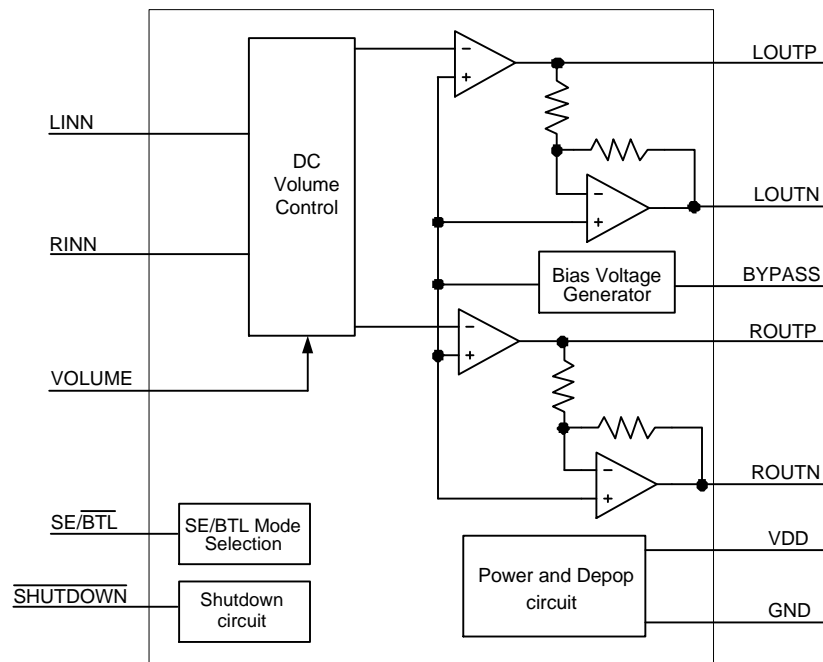
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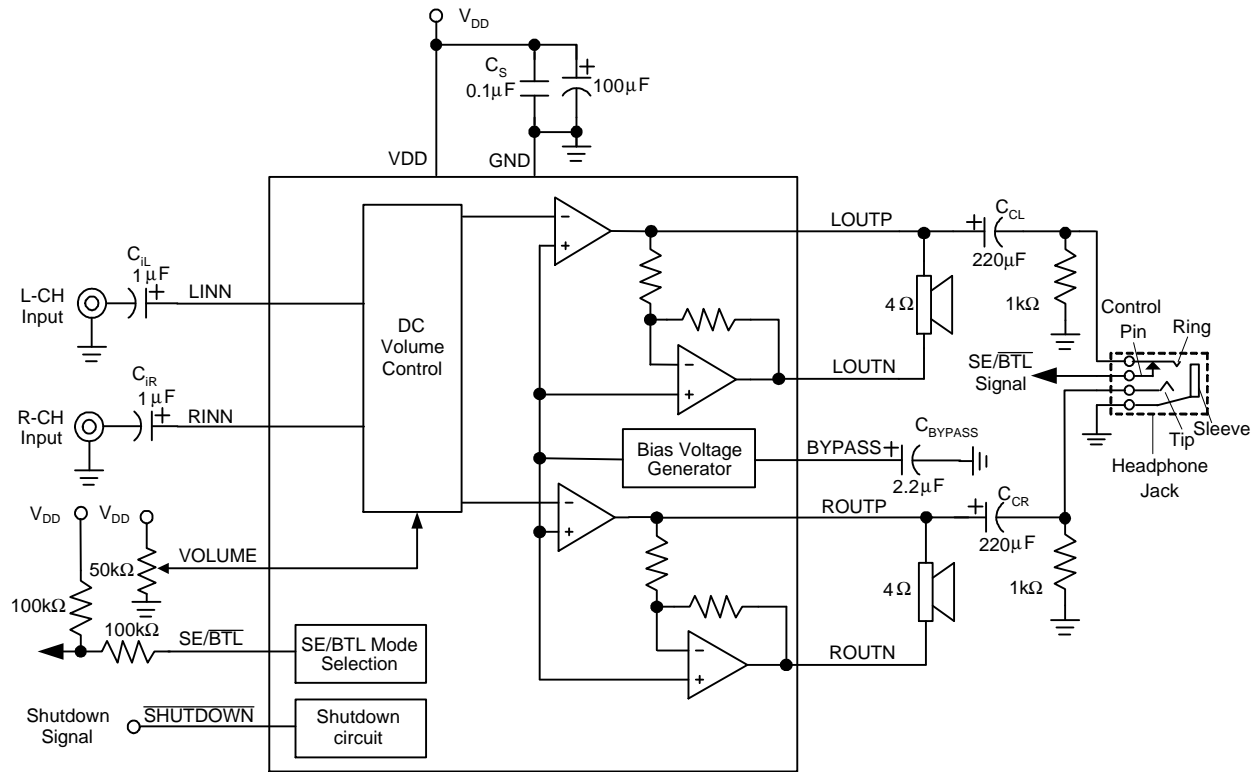
Pin Description

PIN		FUNCTION
NO.	NAME	
1	$\overline{\text{SHUTDOWN}}$	Shutdown control pin. Pulling low the voltage on this pin shuts off the IC. In shutdown mode, the IC only draws 1 μ A (typical) of supply current.
2	BYPASS	Bypass capacitor connection pin for the bias voltage generator.
3	RINNN	Right channel input terminal
4,5,12,13	GND	Ground connection. Connect all of the GND pins to ground plane.
6	LINN	Left channel input terminal
7	VOLUME	DC voltage input pin for internal volume gain setting (DC Volume control).
8	$\text{SE}/\overline{\text{BTL}}$	Output mode control input, high for SE output mode and low for BTL mode.
9	LOUTN	Left channel negative output in BTL mode and high impedance in SE mode.
10,15	VDD	Supply voltage input pin. Connect all of the VDD pins to supply voltage.
11	LOUTP	Left channel positive output in BTL mode and SE mode.
14	ROUTP	Right channel positive output in BTL mode and SE mode.
16	ROUTN	Right channel negative output in BTL mode and high impedance in SE mode.

Block Diagram



Typical Application Circuit



DC Volume Control Table_BTL Mode

Gain(dB)	Voltage Range (% of V _{DD})			Voltage Range (V _{DD} =5V)		
	High(%)	Low(%)	Recommended (%)	High(V)	Low(V)	Recommended (V)
18	2.40	0.00	0.00	0.12	0.00	0.00
17.5	4.60	3.40	4.00	0.23	0.17	0.20
17	6.80	5.60	6.20	0.34	0.28	0.31
16.5	9.20	7.80	8.60	0.46	0.39	0.43
16	11.40	10.20	10.80	0.57	0.51	0.54
15.5	13.80	12.40	13.00	0.69	0.62	0.65
15	16.00	14.60	15.40	0.80	0.73	0.77
14.5	18.20	16.80	17.60	0.91	0.84	0.88
14	20.60	19.20	19.80	1.03	0.96	0.99
13	22.80	21.40	22.00	1.14	1.07	1.10
12	25.00	23.60	24.40	1.25	1.18	1.22
10	27.40	25.80	26.60	1.37	1.29	1.33
8	29.60	28.20	28.80	1.48	1.41	1.44
6	31.80	30.40	31.20	1.59	1.52	1.56
4	34.20	32.60	33.40	1.71	1.63	1.67
2	36.40	34.80	35.60	1.82	1.74	1.78
0	38.60	37.00	37.80	1.93	1.85	1.89
-2	41.00	39.40	40.20	2.05	1.97	2.01
-4	43.20	41.60	42.40	2.16	2.08	2.12
-7	45.60	43.80	44.60	2.28	2.19	2.23
-10	47.80	46.00	47.00	2.39	2.30	2.35
-13	50.00	48.40	49.20	2.50	2.42	2.46
-16	52.40	50.60	51.40	2.62	2.53	2.57
-19	54.60	52.80	53.80	2.73	2.64	2.69
-22	56.80	55.00	56.00	2.84	2.75	2.80
-25	59.20	57.40	58.20	2.96	2.87	2.91
-28	61.40	59.60	60.40	3.07	2.98	3.02
-31	63.60	61.80	62.80	3.18	3.09	3.14
-34	66.00	64.00	65.00	3.30	3.20	3.25
-37	68.20	66.40	67.20	3.41	3.32	3.36
-40	70.40	68.60	69.60	3.52	3.43	3.48
-80	100.00	70.80	100.00	5.00	3.54	5.00

Function Description

Bridge-Tied Load (BTL) Operation

The APA2070's output stage of each channel, which consists of one pair of operational amplifiers, provides option for BTL operation shown as figure 1.

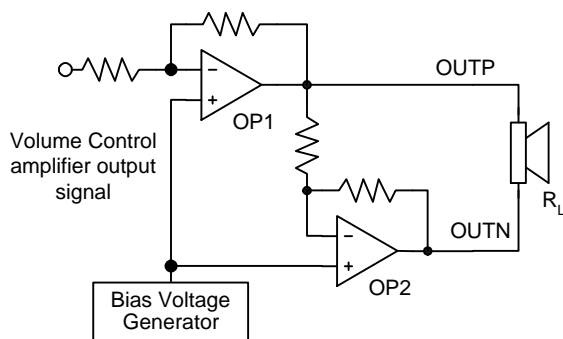


Figure 1: APA2070 Internal Configuration (each channel)

The power amplifier's (OP1) gain is set by internal unity gain and input audio signal comes from internal volume control amplifier while the second amplifier (OP2) is internally fixed in a unity-gain, inverting configuration. Figure 1 shows that the output of OP1 is connected to the input to OP2, which results in the output signals of with both amplifiers with identical in magnitude but out of phase 180°. Consequently, the differential gain for each channel is 2 x (Gain of SE mode).

By driving the load differentially through outputs OUTP and OUTN, an amplifier configuration is commonly referred to bridged mode is established. BTL mode operation is different from the classical single-ended (SE) amplifier configuration where one side of its load is connected to the ground.

A BTL amplifier design has a few distinct advantages over the SE configuration, as it provides differential drive to the load, thus, doubles the output swing for a specified supply voltage.

When placed under the same conditions, a BTL amplifier has four times the output power of a SE amplifier. A BTL configuration, such as the one used in APA2070, also creates a second advantage over SE amplifiers. Since the differential outputs, ROUTP, ROUTN, LOUTP, and LOUTN, are biased at half-supply, it's not necessary for DC voltage to be across the load. This eliminates the need for an output coupling capacitor which is required in a single supply, SE configuration.

Single-Ended (SE) Operation

To consider the single-supply SE configuration shown in Typical Application Circuit, a coupling capacitor is required to block the DC offset voltage from reaching the load. These capacitors can be quite large (approximately 33μF to 1000μF) so they tend to be expensive, occupy valuable PCB area, and have the additional drawback of limiting low-frequency performance of the system (refer to the Output Coupling Capacitor). The rules described still hold with the addition of the following relationship:

$$\frac{1}{C_{\text{bypass}} \times 150\text{k}\Omega} \leq \frac{1}{2R_i C_i} \ll \frac{1}{2R_L C_c} \quad (1)$$

SE/BTL Mode Selection Function

The best saving features of APA2070 is that it can be switched easily between BTL and SE modes. This feature eliminates the requirement for an additional headphone amplifier in applications where internal stereo speakers are driven in BTL mode but external headphone or speakers must be accommodated.

Inside of the APA2070, two separated amplifiers drive OUTP and OUTN (See Figure 1). The SE/BTL input controls the operation of the follower amplifier that drives LOUTP and ROUTN.

- When SE/BTL keeps low, the OP2 turns on and the APA2070 is in the BTL mode.
- When SE/BTL keeps high, the OP2 is in a high output impedance state, which configures the APA2070 as SE driver from OUTP. I_{DD} is reduced by approximately one-half in SE mode.

Control of the SE/BTL input can be a logic-level TTL source or a resistor divider network or the stereo headphone jack with switch pin as shown in the Typical Application Circuit.

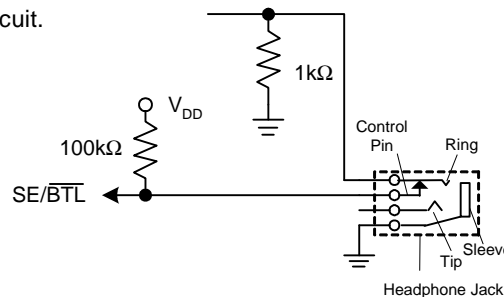


Figure 2: SE/BTL Input Selection by Phonejack Plug

Function Description (Cont.)

SE/BTL Mode Selection Function (Cont.)

In Figure 2, input $\overline{\text{SE/BTL}}$ operates as below:

When the phonejack plug is inserted, the $1\text{k}\Omega$ resistor is disconnected and the $\overline{\text{SE/BTL}}$ input is pulled high to enable the SE mode. Meanwhile, the OUTN amplifier is shut down which turns the speaker to be mute. The OUPN amplifier then drives through the output capacitor into the headphone jack. When there is no headphone plugged into the system, the contact pin of the headphone jack is connected from the signal pin, and the voltage divider is set up by resistors $100\text{k}\Omega$ and $1\text{k}\Omega$. Resistor $1\text{k}\Omega$ then is pulled low the $\overline{\text{SE/BTL}}$ pin, enabling the BTL function.

DC Volume Control Function

The APA2070 has an internal stereo volume control that setting is the function of the DC voltage applied to the VOLUME input pin. The APA2070 volume control consists of 32 steps that are individually selected by a variable DC voltage level on the VOLUME control pin. The range of the steps, controlled by the DC voltage, are from 18dB to -80dB. Each gain step corresponds to a specific input voltage range, as shown in table. To minimize the effect of noise on the volume control pin, which can affect the selected gain level, hysteresis and clock delay are implemented. The amount of hysteresis corresponds to half of the step width, as shown in the volume control graph.

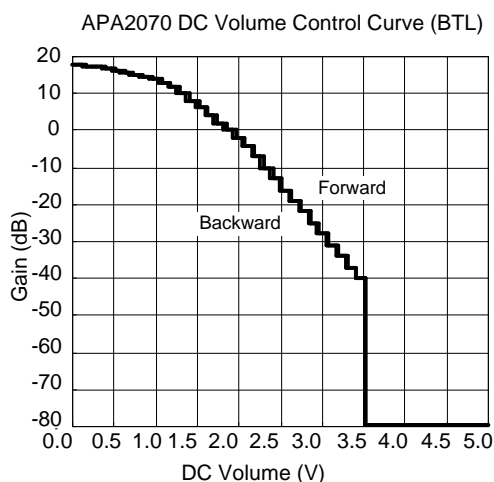


Figure 3: Gain setting vs. VOLUME pin voltage

For the highest accuracy, the voltage shown in the 'recommended voltage' column of the table is used to select a desired gain. This recommended voltage is exactly half-way between the two nearest transitions. The gain levels are 32 steps from 18dB to -40dB in BTL mode, and the last step at -80dB as mute mode.

Shutdown Function

In order to reduce power consumption while not in use, the APA2070 contains a shutdown pin to externally turn off the amplifier bias circuitry. This shutdown feature turns the amplifier off when a logic low is placed on the $\overline{\text{SHUTDOWN}}$ pin. The trigger point between a logic high and logic low level is typically 2.0V. It would be better to switch between the ground and the supply V_{DD} to provide maximum device performance.

By switching the $\overline{\text{SHUTDOWN}}$ pin to low, the amplifier enters a low-current state, $I_{DD} < 1\mu\text{A}$. APA2070 is in shutdown mode. On normal operation, $\overline{\text{SHUTDOWN}}$ pin is pulled to high level to keep the IC out of the shutdown mode. The $\overline{\text{SHUTDOWN}}$ pin should be tied to a definite voltage to avoid unwanted state changing.

Thermal Protection

The thermal protection circuit limits the junction temperature of the APA2070. When the junction temperature exceeds $T_j = +150^\circ\text{C}$, a thermal sensor turns off the amplifier, allowing the devices to cool. The thermal sensor allows the amplifier to start-up after the junction temperature down about 125°C . The thermal protection is designed with a 25°C hysteresis to lower the average T_j during continuous thermal overload conditions, which is increasing lifetime of the IC.

Over-Current Protection

The APA2070 monitors the output current. When the current exceeds the current-limit threshold, the APA2070 turns off the output to prevent the IC from damages in over-current or short-circuit condition. When the over-current occurs in power amplifier, the output buffer's current will be foldbacked to a low setting level, and it will release when over-current situation is no long existence. On the contrary, if the over-current period is long enough and the IC's junction temperature reaches the thermal protection threshold, the IC will enter thermal protection mode.

Application Information

Input Resistance (R_i)

The gain for each audio input of the APA2070 is set by the internal resistors (R_i and R_F) of volume control amplifier in inverting configuration.

$$SE\ Gain = A_V = -\frac{R_F}{R_i} \quad (2)$$

$$BTL\ Gain = -2 \times \frac{R_F}{R_i} \quad (3)$$

BTL mode operation brings the factor of 2 in the gain equation due to the inverting amplifier mirroring the voltage swing across the load. For varying gain settings, the APA2070 generates each input resistance on figure 4. The input resistance will affect the low frequency performance of audio signal. The minimum input resistance is 30kΩ when gain setting is 18dB and the resistance will ramp up when close loop gain below 18dB. The input resistance has wide variation (+/-10%) caused by process variation.

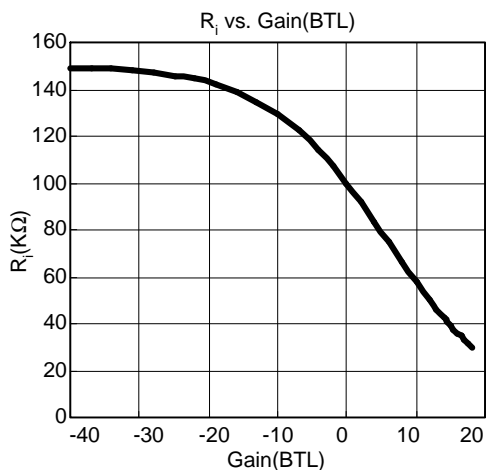


Figure 4: Input resistance vs. Gain setting

Input Capacitor (C_i)

In the typical application, an input capacitor (C_i) is required to allow the amplifier to bias the input signal to the proper DC level for optimum operation. In this case, C_i and the minimum input impedance R_i (30kΩ) form a high-pass filter with the corner frequency determined in the following equation :

$$F_{C(\text{highpass})} = \frac{1}{2\pi \times 30k\Omega \times C_i} \quad (4)$$

The value of C_i must be considered carefully because it directly affects the low frequency performance of the circuit. Consider the example where R_i is 30kΩ and the specification calls for a flat bass response down to 50Hz. Equation is reconfigured below :

$$C_i = \frac{1}{2\pi \times 30k\Omega \times F_C} \quad (5)$$

When variation of input resistance (R_i) is considered, the C_i should be 0.1μF, so a value in the range of 0.047μF to 0.47μF would be chosen. A further consideration for this capacitor is the leakage path from the input source through the input network (R_i+R_F, C_i) to the load. This leakage current creates a DC offset voltage at the input to the amplifier that reduces useful headroom, especially in high gain applications. For this reason, a low-leakage tantalum or ceramic capacitor is the best choice. When polarized capacitors are used, the positive side of the capacitor should face the amplifier input in most applications as the DC level there is held at V_{DD}/2. Please note that it is important to confirm the capacitor polarity in the application.

Effective Bypass Capacitor (C_{BYPASS})

A power amplifier, proper supply bypassing, is critical for low noise performance and high power supply rejection.

The capacitor location on the BYPASS pin should be as close to the device as possible. The effect of a larger supply bypass capacitor is to improve PSRR due to increased half-supply stability. Two critical criteria of bypass capacitor (C_{BYPASS}): 1st, it depends upon desired PSRR requirements and click-and-pop performance; 2nd, the leakage current of C_{BYPASS} will induce the voltage drop of V_{BYPASS} (voltage of BYPASS pin), and if the V_{BYPASS} is less than 0.49V_{DD}, the APA2070 will enter mute condition. The value of V_{BYPASS} can be calculated as below:

$$V_{BYPASS} = 0.5V_{DD} - I_{Leakage} \times 150k\Omega \quad (6)$$

Where

$$I_{Leakage} = \text{Leakage current of } C_{BYPASS}$$

Therefore, it is recommended that C_{BYPASS}'s leakage current should be no more than 0.4μA for properly work of the APA2070.

Application Information (Cont.)

Effective Bypass Capacitor (C_{BYPASS})(Cont.)

To avoid the start-up pop noise, the bypass voltage should rise slower than the input bias voltage and the relationship shown in equation should be maintained.

$$\frac{1}{(C_{\text{BYPASS}} \times 150\text{k}\Omega)} \ll \frac{1}{C_i \times 150\text{k}\Omega} \quad (7)$$

The capacitor is fed from a 150kΩ resistor inside of the amplifier and the 150kΩ is the maximum input resistance of ($R_i + R_F$). Bypass capacitor, C_{BYPASS} , values of 2.2μF to 10μF ceramic or tantalum low-ESR capacitors are recommended for the best THD+N and noise performance.

The bypass capacitance also affects the start-up time. It is determined in the following equation:

$$T_{\text{start up}} = 5X(C_{\text{BYPASS}} \times 150\text{k}\Omega) \quad (8)$$

Output Coupling Capacitor (C_c)

In the typical single-supply SE configuration, an output coupling capacitor (C_c) is required to block the DC bias at the output of the amplifier thus preventing DC currents in the load. As with the input coupling capacitor, the output coupling capacitor and impedance of the load form a high-pass filter governed by the equation.

$$F_{C(\text{highpass})} = \frac{1}{2\pi R_L C_c} \quad (9)$$

For example, a 330μF capacitor with an 8Ω speaker would attenuate low frequencies below 60.6Hz. The main disadvantage, from a performance standpoint, is the load impedance is typically small, which drives the low-frequency corner higher degrading the bass response. Large values of C_c are required to pass low frequencies into the load.

Power Supply Decoupling Capacitor (C_s)

The APA2070 is a high-performance CMOS audio amplifier that requires adequate power supply decoupling to ensure the output total harmonic distortion (THD+N) is as low as possible. Power supply decoupling also prevents the oscillations caused by long lead length between the amplifier and the speaker. The optimum decoupling is achieved by using two different types of capacitors that target on different types of noise on the power supply leads.

For higher frequency transients, spikes, or digital hash on the line, a good low equivalent-series-resistance (ESR) ceramic capacitor, typically 0.1μF, is placed as close as possible to the device V_{DD} lead works best. For filtering lower-frequency noise signals, it is recommended to place a large aluminum electrolytic capacitor of 10μF or greater near the audio power amplifier

Optimizing Depop Circuitry

Circuitry has been included in the APA2070 to minimize the amount of popping noise at power-up and when coming out of shutdown mode. Popping occurs whenever a voltage step is applied to the speaker. In order to eliminate clicks and pops, all capacitors must be fully discharged before turn-on. Rapid on/off switching of the device or the shutdown function will cause the click and pop circuitry.

The value of C_i will also affect turn-on pops (Refer to Effective Bypass Capacitance). The bypass voltage ramp up should be slower than input bias voltage. Although the bypass pin current source cannot be modified, the size of C_{BYPASS} can be changed to alter the device turn-on time and the amount of clicks and pops. By increasing the value of C_{BYPASS} , turn-on pop can be reduced. However, the tradeoff for using a larger bypass capacitor is to increase the turn-on time for this device. There is a linear relationship between the size of C_{BYPASS} and the turn-on time. In a SE configuration, the output coupling capacitor (C_c), is of particular concern.

This capacitor discharges through the internal 10kΩ resistors. Depending on the size of C_c , the time constant can be relatively large. To reduce transients in SE mode, an external 1kΩ resistor can be placed in parallel with the internal 10kΩ resistor. The tradeoff for using this resistor is an increase in quiescent current. In most cases, choosing a small value of C_i in the range of 0.33μF to 1μF, C_{BYPASS} being equal to 4.7μF and an external 1kΩ resistor should be placed in parallel with the internal 10kΩ resistor should produce a virtually clickless and popless turn-on.

A high gain amplifier intensifies the problem as the small delta in voltage is multiplied by the gain, so it is advantageous to use low-gain configurations.

Application Information (Cont.)

BTL Amplifier Efficiency

An easy-to-use equation to calculate efficiency starts out as being equal to the ratio of power from the power supply to the power delivered to the load.

The following equations are the basis for calculating amplifier efficiency.

$$\text{Efficiency} = \frac{P_o}{P_{SUP}} \quad (10)$$

Where

$$P_o = \frac{V_{O,RMS}^2}{R_L} = \frac{V_P^2}{2R_L}$$

$$V_{O,RMS} = \frac{V_P}{\sqrt{2}} \quad (11)$$

$$P_{SUP} = V_{DD} \times I_{DD,AVG} = V_{DD} \times \frac{2V_P}{\pi R_L} \quad (12)$$

Efficiency of a BTL configuration :

$$\frac{P_o}{P_{SUP}} = \frac{\frac{V_P^2}{2R_L}}{V_{DD} \times \frac{2V_P}{\pi R_L}} = \frac{\pi V_P}{4V_{DD}} \quad (13)$$

Table 1 is for calculating efficiencies for four different output power levels.

Note that the efficiency of the amplifier is quite low for lower power levels and rises sharply as power to the load is increased resulting in a nearly flat internal power dissipation over the normal operating range. In addition, the internal dissipation at full output power is less than in the half power range. Calculating the efficiency for a specific system is the key to proper power supply design. For a stereo 1W audio system with 8Ω loads and a 5V supply, the maximum draw on the power supply is almost 3W.

A final point to remember about linear amplifiers (either SE or BTL) is how to manipulate the terms in the efficiency equation to utmost advantage when possible. Note that in equation, V_{DD} is in the denominator. This indicates that as the V_{DD} goes down, efficiency goes up. In other words, use the efficiency analysis to choose the correct supply voltage and speaker impedance for the application.

Po (W)	Efficiency (%)	I _{DD} (A)	V _{PP} (V)	P _D (W)
0.25	31.25	0.16	2.00	0.55
0.50	47.62	0.21	2.83	0.55
1.00	66.67	0.30	4.00	0.5
1.25	78.13	0.32	4.47	0.35

**High peak voltages cause the THD+N to increase.

Table 1. Efficiency vs. Output Power in 5-V/8Ω BTL Systems

Power Dissipation

Whether the power amplifier is operated in BTL or SE mode, power dissipation is the major concern. Equation (14) states the maximum power dissipation point for a SE mode operating at a given supply voltage and driving a specified load.

$$\text{SE mode: } P_{D,MAX} = \frac{V_{DD}^2}{2\pi^2 R_L} \quad (14)$$

In BTL mode operation, the output voltage swing is doubled as in SE mode. Thus, the maximum power dissipation point for a BTL mode operating at the same given conditions is 4 times as in SE mode.

$$\text{BTL mode: } P_{D,MAX} = \frac{4V_{DD}^2}{2\pi^2 R_L} \quad (15)$$

Since the APA2070 is a dual channel power amplifier, the maximum internal power dissipation is 2 times that both of equations depend on the mode of operation. Even with this substantial increase in power dissipation, the APA2070 does not require extra heatsink. The power dissipation from equation (14), assuming a 5V-power supply and an 8Ω load, must not be greater than the power dissipation that results from the equation (16):

$$P_{D,MAX} = \frac{T_{J,MAX} - T_A}{\theta_{JA}} \quad (16)$$

For DIP-16/DIP-16A package, the thermal resistance (θ_{JA}) is equal to 45°C/W.

Since the maximum junction temperature ($T_{J,MAX}$) of the APA2070 is 150°C and the ambient temperature (T_A) is defined by the power system design, the maximum power dissipation which the IC package is able to handle can be obtained from equation 16.

Application Information (Cont.)

Power Dissipation (Cont.)

Once the power dissipation is greater than the maximum limit ($P_{D,MAX}$), either the supply voltage (V_{DD}) must be decreased, the load impedance (R_L) must be increased or the ambient temperature should be reduced.

Thermal Consideration

Linear power amplifiers dissipate a significant amount of heat in the package under normal operating conditions. The first consideration to calculate maximum ambient temperatures is the numbers from the Power Dissipation vs. Output Power graphs are per channel values, so the dissipation of the IC heat needs to be doubled for two-channel operation. Given θ_{JA} , the maximum allowable junction temperature (T_{JMAX}), and the total internal dissipation (P_D), the maximum ambient temperature can be calculated with the following equation. The maximum recommended junction temperature for the APA2070 is 150°C. The internal dissipation figures are taken from the Power Dissipation vs. Output Power graphs.

$$T_{AMax} = T_{JMax} - \theta_{JA} P_D \quad (16)$$

$$150 - 45(0.8*2) = 78^\circ\text{C}$$

The APA2070 is designed with a thermal shutdown protection that turns the device off when the junction temperature surpasses 150°C to prevent damaging the IC.

Layout Consideration

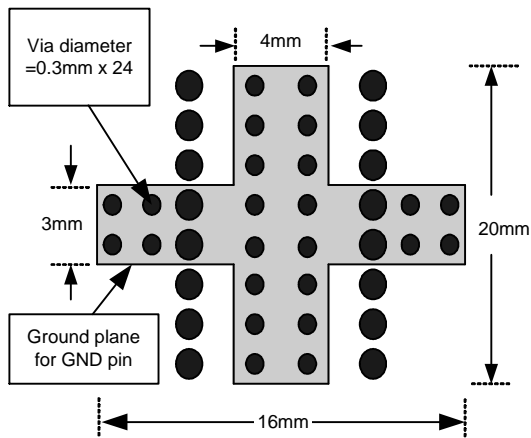
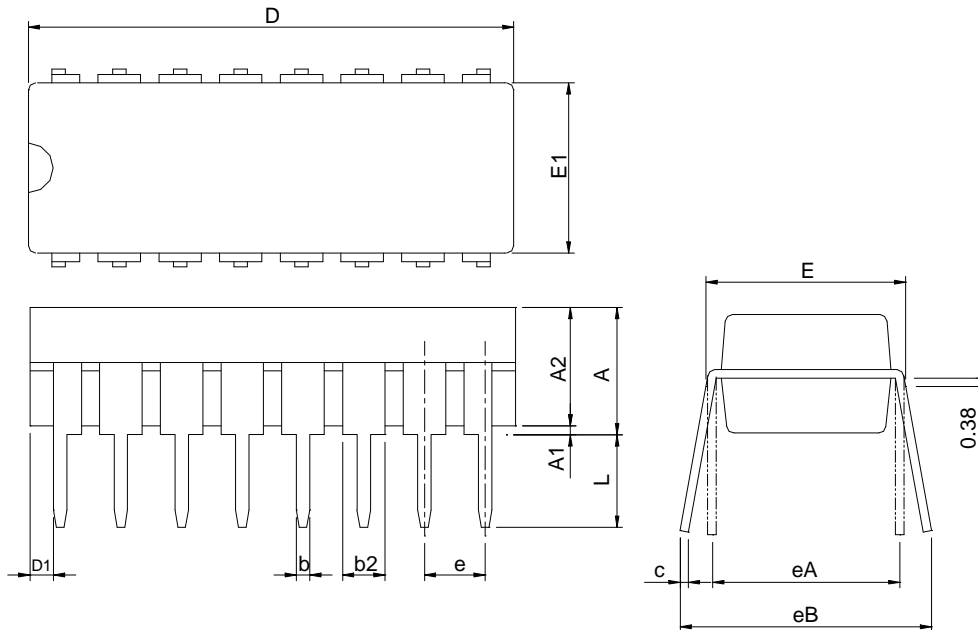


Figure 5: APA 2070 Land Pattern Recommendation

1. All components should be placed close to the APA2070. For example, the input capacitor (C_i) should be close to APA2070's input pins to avoid causing noise coupling to APA2070's high impedance inputs; the decoupling capacitor (C_s) should be placed by the APA2070's power pin to decouple the power rail noise.
2. The output traces should be short, wide (>50mil), and symmetric.
3. The input trace should be short and symmetric.
4. The power trace width should be greater than 50mil.
5. The APA2070's GND pin should be soldered on the ground plane of the PCB.

Package Information

DIP-16

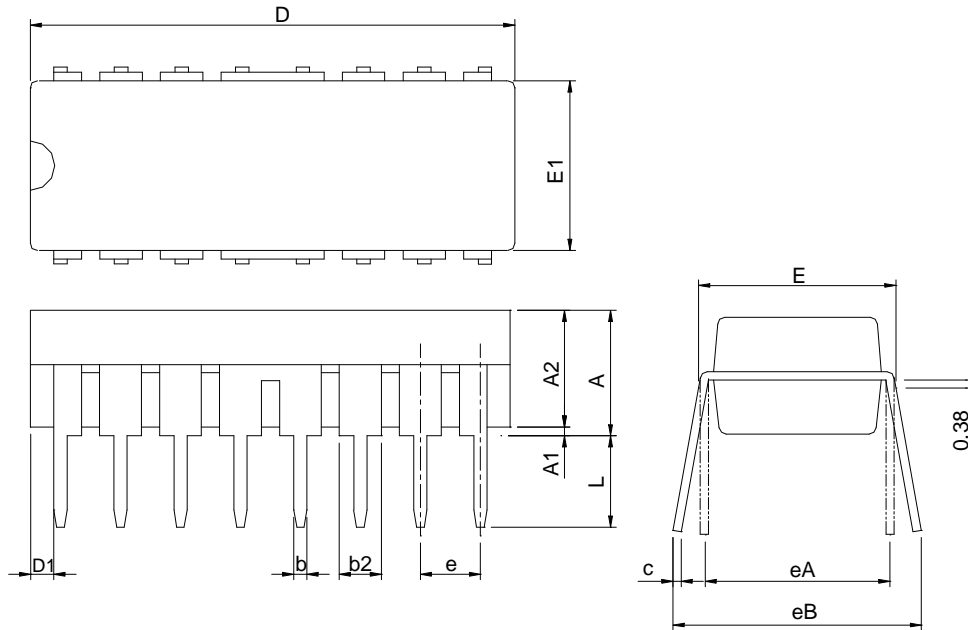


DIMENSIONS	DIP-16			
	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.
A		5.33		0.210
A1	0.38		0.015	
A2	2.92	4.95	0.115	0.195
b	0.36	0.56	0.014	0.022
b2	1.14	1.78	0.045	0.070
c	0.20	0.35	0.008	0.014
D	18.6	20.31	0.732	0.800
D1	0.13		0.005	
E	7.62	8.26	0.300	0.325
E1	6.10	7.11	0.240	0.280
e	2.54 BSC		0.100 BSC	
eA	7.62 BSC		0.300 BSC	
eB		10.92		0.430
L	2.92	3.81	0.115	0.150

Note : 1. Followed from JEDEC MS-001AB
 2. Dimension D, D1 and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 10 mil.

Package Information

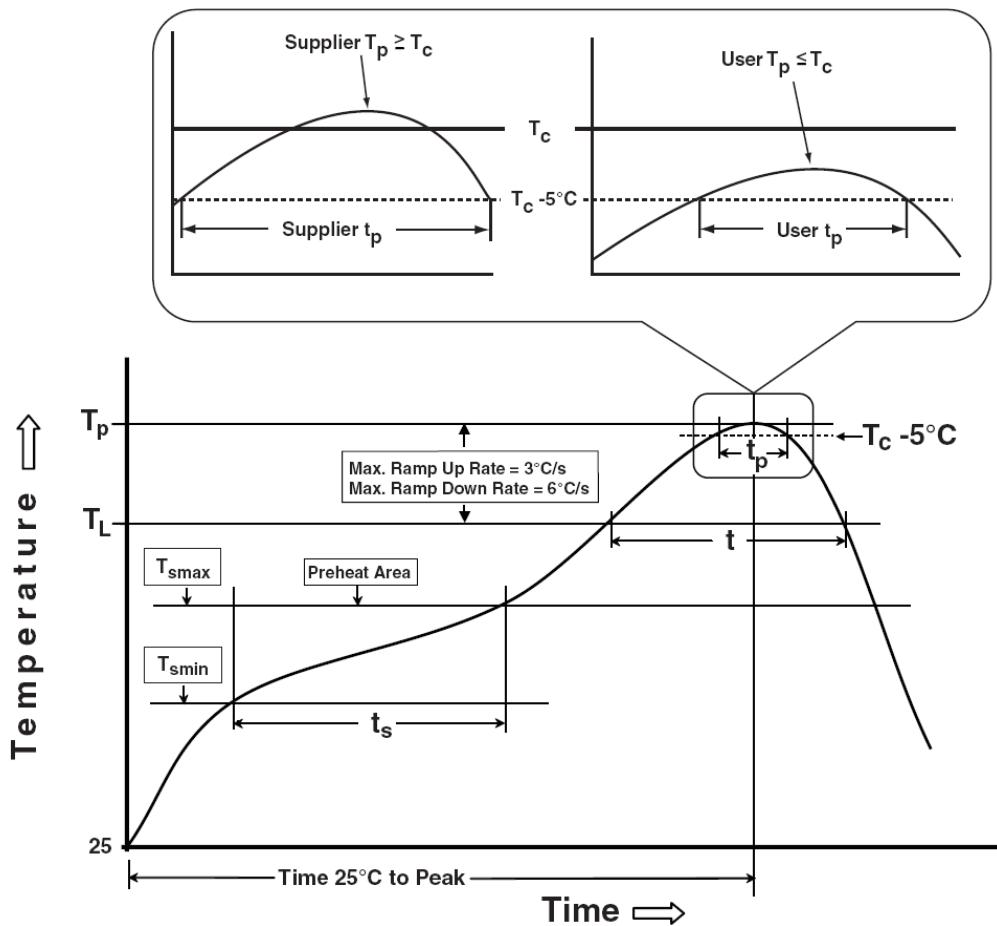
DIP-16A



DIMENSIONS	DIP-16A			
	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.
A		5.33		0.210
A1	0.38		0.015	
A2	2.92	4.95	0.115	0.195
b	0.36	0.56	0.014	0.022
b2	1.14	1.78	0.045	0.070
c	0.20	0.35	0.008	0.014
D	18.6	20.31	0.732	0.800
D1	0.13		0.005	
E	7.62	8.26	0.300	0.325
E1	6.10	7.11	0.240	0.280
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L	2.92	3.81	0.115	0.150

- Note : 1. Followed from JEDEC MS-001AB
 2. Dimension D, D1 and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 10 mil.

Classification Profile



Classification Reflow Profiles

Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
Preheat & Soak		
Temperature min (T_{smin})	100 °C	150 °C
Temperature max (T_{smax})	150 °C	200 °C
Time (T_{smin} to T_{smax}) (t_s)	60-120 seconds	60-120 seconds
Average ramp-up rate (T_{smax} to T_p)	3 °C/second max.	3°C/second max.
Liquidous temperature (T_L)	183 °C	217 °C
Time at liquidous (t_L)	60-150 seconds	60-150 seconds
Peak package body Temperature (T_p)*	See Classification Temp in table 1	See Classification Temp in table 2
Time (t_p)** within 5°C of the specified classification temperature (T_c)	20** seconds	30** seconds
Average ramp-down rate (T_p to T_{smax})	6 °C/second max.	6 °C/second max.
Time 25°C to peak temperature	6 minutes max.	8 minutes max.
* Tolerance for peak profile Temperature (T_p) is defined as a supplier minimum and a user maximum.		
** Tolerance for time at peak profile temperature (t_p) is defined as a supplier minimum and a user maximum.		

Classification Reflow Profiles (Cont.)

Table 1. SnPb Eutectic Process – Classification Temperatures (Tc)

Package Thickness	Volume mm ³ <350	Volume mm ³ ≥350
<2.5 mm	235 °C	220 °C
≥2.5 mm	220 °C	220 °C

Table 2. Pb-free Process – Classification Temperatures (Tc)

Package Thickness	Volume mm ³ <350	Volume mm ³ 350-2000	Volume mm ³ >2000
<1.6 mm	260 °C	260 °C	260 °C
1.6 mm – 2.5 mm	260 °C	250 °C	245 °C
≥2.5 mm	250 °C	245 °C	245 °C

Reliability Test Program

Test item	Method	Description
SOLDERABILITY	JESD-22, B102	5 Sec, 245°C
HOLT	JESD-22, A108	1000 Hrs, Bias @ Tj=125°C
PCT	JESD-22, A102	168 Hrs, 100%RH, 2atm, 121°C
TCT	JESD-22, A104	500 Cycles, -65°C~150°C
HBM	MIL-STD-883-3015.7	VHBM 2KV
MM	JESD-22, A115	VMM 200V
Latch-Up	JESD 78	10ms, 1 _{tr} 100mA

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